

CUSTOM

MSSR

ISSR

Product Overview

EMR

COAX

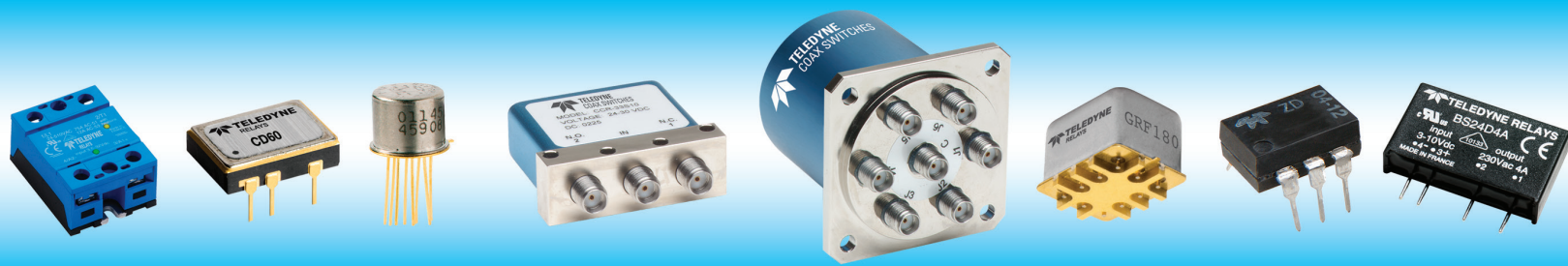


TELEDYNE RELAYS
TELEDYNE COAX SWITCHES
Everywhereyoulook™

SPACE

MATRIX

InP



Switching Solutions

Teledyne Relays is the world's innovative leader in manufacturing ultra-miniature hermetically sealed switching products, with more than 50 years heritage in military programs. Our comprehensive product line meets wide-ranging requirements for the defense and aerospace markets, covering frequencies from DC to 52GHz with our Coaxial products, and DC-18GHz with signal integrity up to 40Gbps with our High-Frequency electro-mechanical relays. We also offer high-performance solutions for industrial, telecom, commercial, and medical switching applications.

Business Focus

- QPL & COTS Electromechanical Relays
- QPL & COTS Solid-State Relays
- Industrial Solid-State Relays
- High-Frequency Relays and Coaxial Switches
- Space (Hi-Rel) Relays & Coaxial Switches
- COTS & Custom RF Switch Matrices
- Military and Space Grade Optocouplers
- Hybrid Solutions, SSPC, DC-DC Converters

Markets We Serve

- Commercial & Military Aviation
- Defense & Aerospace
- Telecom/Communications (Wireless)
- Instrumentation & Test
- Industrial Power & Motion Control
- Medical Applications
- IC Semiconductor Test
- Oil & Gas

Product Assurance & Technical Service



CERTIFICATE
OF REGISTRATION

This is to certify that the management system of:

Teledyne Relays

Main Site: 12525 Daphne Avenue, Hawthorne, California, 90250-3308, USA
 Additional Site: NORTH AMERICAN PRODUCTION SHARING OF MEXICO, S.A. DE C.V., Teledyne Relays Division, Blvd. Diaz Ordaz #1131, Tijuana, 92143, Mexico

Has been audited and registered by Intertek as meeting the requirements of the standards:

AS9100:D and ISO 9001:2015

The management system is applicable to:

Multiple Site Structure

Main Site Scope: The Design, Manufacture and Distribution of Relays.
 Additional Site Scope: The Manufacture of Electromechanical Relays.

Certificate Number
95-869-11

Initial Certification Date
16 November 1995

Certificate Issue Date
27 March 2020

Certificate Reissue Date

Certificate Expiry Date
26 March 2023



Intertek

Calin Moldoveanu
President, Business Assurance

Intertek Testing Services NA, Inc. dba Intertek
4700 Broadview Avenue S.E.,
Kentwood, MI, USA



The assessment was performed in accordance with the requirements of ISO/IEC 17021:2015. Intertek is accredited under the Aerospace Regional Management Program and ISO/IEC 17021:2015. The issuance of this certificate, internal assurance is liability to any party other than to the Client, and then only in accordance with the agreed upon Certification Agreement. The certificate's validity is subject to the organization maintaining their system in accordance with Intertek's requirements for system certification. Validity may be confirmed via email at certification@intertek.com or by scanning the code to the right with a smartphone. The certificate remains the property of Intertek, to whom it must be returned upon request.
 CT-AS9100-2020-AS9100-1-ANAB-EN-17-01-21-07

Under an aggressive Total Quality Management (TQM) program, Teledyne Relays has embraced a “continuous improvement” culture. With recognized certifications such as AS/EN/JISQ9100:2009 (REV D), ISO 9001/2015, DSCC MIL-STD-790 and Boeing D6-82479, Teledyne Relays has become a primary supplier of switching solutions with the highest quality and reliability to industry leaders around the world.

Teledyne Relays provides easy access to technical service and customer support. An innovative, integrated website makes it easy to find technical information, buy relays and even get e-mail responses within 24 hours. Design engineers who need switching solutions for their electronic systems can find them available on our website.



RoHS or Non-RoHS:
Your Choice!

High Performance Switches For Your High-Frequency Application



Teledyne Relays offers low signal, hermetic, electromechanical relays for high-reliability applications across multiple markets.



RF RELAYS

- Signal Integrity up to 40Gbps
- DC - 18GHz
- SPDT Non Latch & Latching
- Hermetically Sealed
- 3 Million Cycle Life



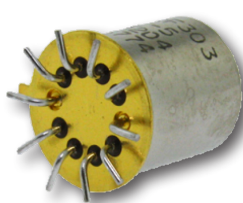
RF Performance			
Frequency (GHz)	VSWR	Isolation (dB)	Insertion Loss (dB)
DC-4	1.20:1	65	0.12
4-8	1.25:1	50	0.15
8-12	1.28:1	45	0.20
12-16	1.75:1	40	0.50
16-18	1.95:1	30	0.85

[Link to datasheet](#)

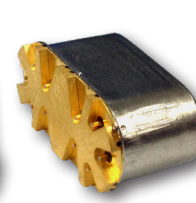
SPDT



DPDT

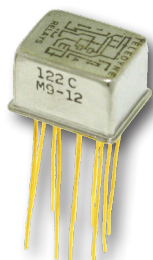


LOOPBACK



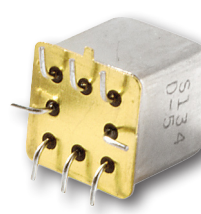
COMMERCIAL RELAYS

LATCHING



- Economical Switching Solutions
 - Short Lead Times
 - Hermetically Sealed
 - 10 Million Cycle Life
- 1A/28Vdc Resistive Load Rating
- Transistor and CMOS driver options

NON-LATCHING



HIGH PERFORMANCE RELAYS

HIGH TEMPERATURE

- -65°C to +200°C
- DPDT
- Non-latching
- Latching
- Sensitive non-latch
- 412H, 422H, 432H



HIGH SHOCK

- Shock up to 4,000 g's
- -65°C to +125°C
- DPDT
- Latching & Non-latch
- 412K, 422K



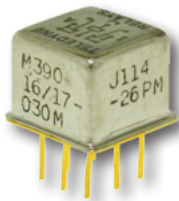
HIGH VIBRATION

- Vibration up to 380 g's
- 10M Life Cycle
- DPDT, non-latching
- Internal Diode option
- 412V, 412DV



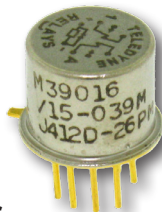
MILITARY GRADE JAN RELAYS

QPL Qualified Parts



J114

- MIL-PRF-39016
- MIL-PRF-28776
- SPDT, DPDT
- Latching & Non-latch
- TO-5, .100 Centigrd
- CMOS Transistor Driver
- TVS & Polarity Diodes



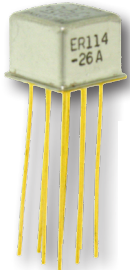
J412D

- DPDT 1/2 Crystal Can
- Resistive: 2A/28Vdc
- MIL-PRF-39016/45 Qualified
- Hermetically Sealed
- 1 Million Cycle Life

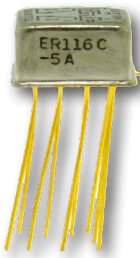


J255

ESTABLISHED RELIABILITY RELAYS



ER114



ER116C

- A & B Level Screening
- More Spacer/spreader pad options
- Added Ground Pin Option
- Reduced Cost
- Reduced Leadtime



ER420



ER432

EMR SCREENING LEVELS

INSPECTION	Screening Levels			
	A Level 1.5%/10K Cycles	B Level .75%/10K Cycles	JAN L Level 3%/10K Cycles	JAN M Level 1%/10K Cycles
Subgroup 1				
Screening, Internal Moisture AQL ¹	✓	✓	✓	✓
Vibration (Sinusoidal) AQL ¹			✓	
Vibration (Sinusoidal) 100%		✓		✓
Screening, Burn-In (Hybrids only)			✓	✓
Screening, Run-In (Room Temperature)	✓			
Screening, Run-In (+125°C and -65°C)		✓	✓	✓
Subgroup 2				
Coil Resistance or Coil Current	✓	✓	✓	✓
Insulation Resistance	✓	✓	✓	✓
Dielectric Withstanding Voltage	✓	✓	✓	✓
Static Contact Resistance	✓	✓	✓	✓
Pickup and Dropout or Set and Reset Voltage	✓	✓	✓	✓
Operate and Release or Set and Reset Time	✓	✓	✓	✓
Hold Voltage			✓	✓
Turn-On and Turn-Off Time (Hybrids only)	✓	✓	✓	✓
Contact Bounce Time	✓		✓	
Contact Stabilization Time		✓		✓
Turn-On Current (T Hybrids only)	✓	✓	✓	✓
Turn-On Voltage (C Hybrids only)	✓	✓	✓	✓
Turn-Off Voltage (Hybrids only)	✓	✓	✓	✓
Coil Transient Suppression (D, DD and Hybrids only)	✓	✓	✓	✓
Diode Blocking Integrity (DD only)	✓	✓	✓	✓
Zener Voltage (C Hybrid only)	✓	✓	✓	✓
Neutral Screen (Latching Relays only)	✓	✓	✓	✓
Break Before Make Verification			✓	✓
Contact Simultaneity			✓	✓
Subgroup 3				
Solderability 2 Samples per Daily Solderability Inspection Lot	✓	✓	✓	✓
Leak Test	✓	✓	✓	✓
External Visual and Mechanical Inspection 2/Lot for Dimension and Weight Check	✓	✓	✓	✓

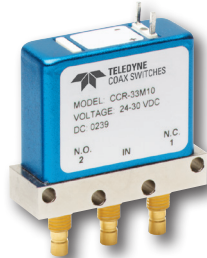
Teledyne Coax Switches offers a large portfolio of coaxial switches with a wide frequency range from DC to 53GHz.



SPDT SWITCHES



CR-50U
DC-53GHz



CCR-33M
DC-3GHz



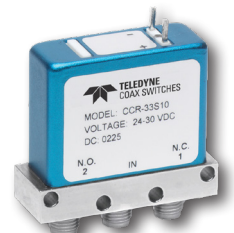
CCR-33S
DC-18GHz



CRT-33S
DC-22GHz



CCS-32N
DC-12GHz



CCR-53S
DC-26.5GHz

- Operating Frequency from **DC - 53GHz**
- Excellent Insertion Loss Repeatability
- Characterized at 5 million cycles
- Compact design with High performance

OPTIONS

- Failsafe or Latching
- Internal 50 Ω Termination
- 12, 15, 24, or 28Vdc Actuation
- SMA, TNC, N, 2.92mm & 2.4mm
- Indicators, Self Cutoff (Latching Only)
- TTL, Diodes, Moisture Seal, D-Sub

MULTI-THROW SWITCHES

- DC - 52GHz
- Internal 50 Ω Termination
- SMA, 2.92mm, TNC, N, & U
- SP3T - SP12T
- 5 Million Cycles
- Normally Open & Latching



CR-39U
DC-52GHz



CCT-58S SP12T
DC-18GHz



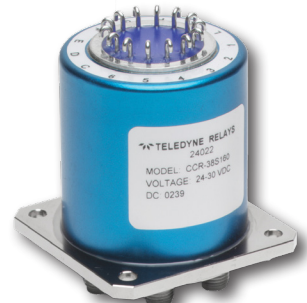
CCS-18
DC-12GHz



CCR-39S SP10T
DC-18GHz



CCR-58S
DC-26.5GHz



CCR-48K
DC-40GHz

TRANSFER & 2P3T SWITCHES



CR-37U
DC-52GHz

- Operating Frequency from **DC - 52GHz**
- SMA, 2.92mm, TNC, N, & U
- 5 Million Cycles
- High Power N & TNC
- Failsafe & Latching



CCS-47N
DC-12GHz



CCS-37K
DC-40GHz

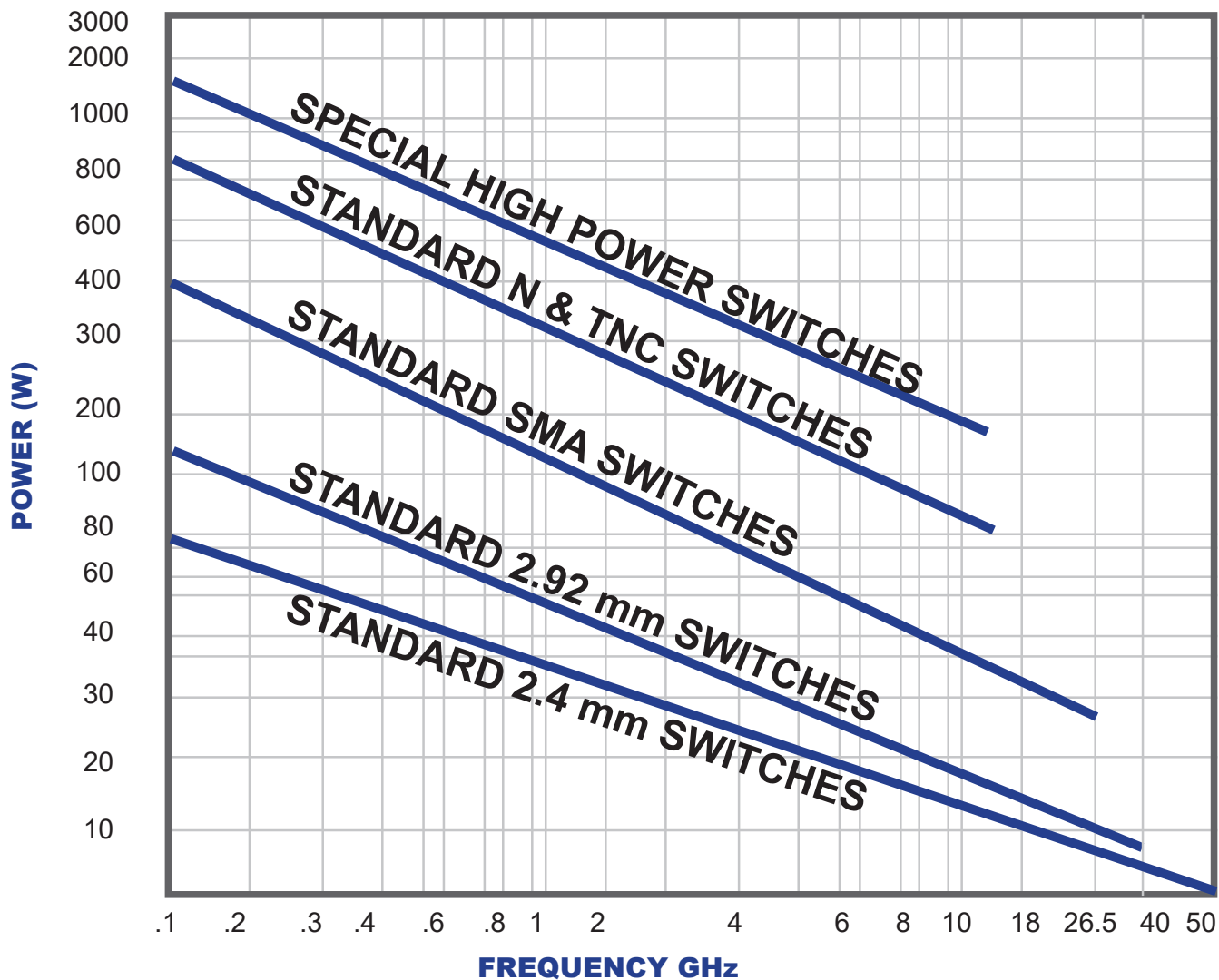


CCRS-33S
DC-18GHz



CCS-37S
DC-26.5GHz

POWER VS FREQUENCY



MATRIX



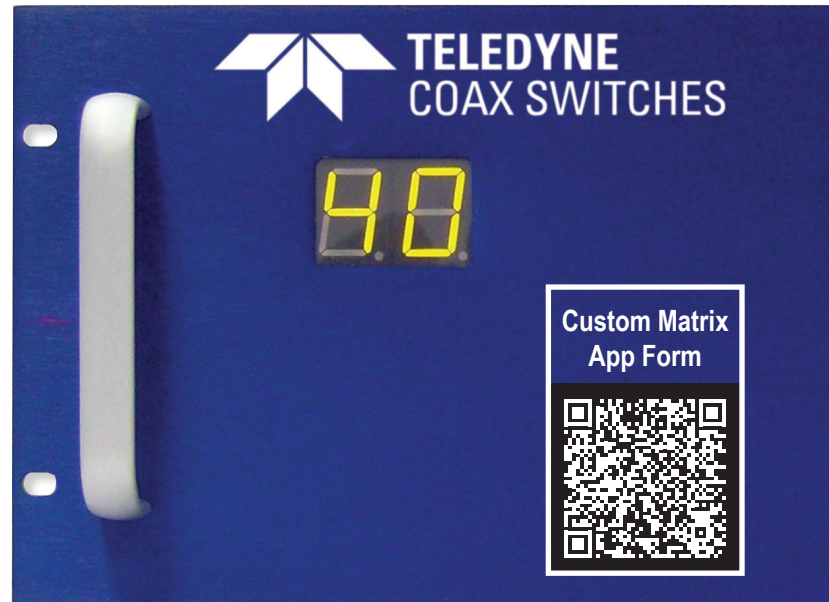
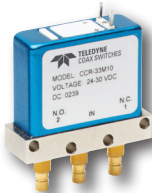
Teledyne, the world's innovative leader in manufacturing electromechanical and solid-state switching products for more than 50 years, offers a modular approach to matrix

assembly switching. Incorporating highly repeatable and long-cycle-life relays and switches, Teledyne's matrices cover the spectrum from DC to 53GHz. Teledyne's modular approach to building matrices allows assembly of a vast array of customized matrix assemblies with the same standard sub-assemblies. The internal components of the assembly and main module utilize Teledyne's proven relays



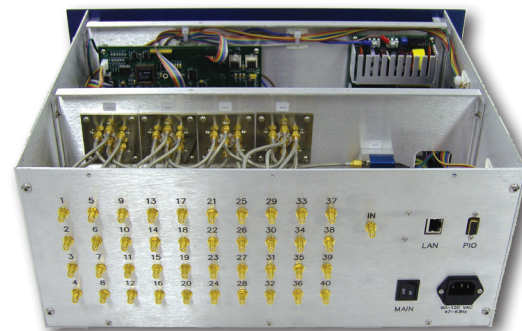
and switches. Teledyne has developed a standard programmable microcontroller that can be used for nearly any matrix configuration. The universal power supply allows the matrix assembly to be used worldwide. Teledyne is highly vertically integrated, which reduces development time, qualification time, cost and lead time, while ensuring high quality and cost-effective production.

To learn more, call us or visit us online today. And see what Teledyne Coaxial Switches can do for you.

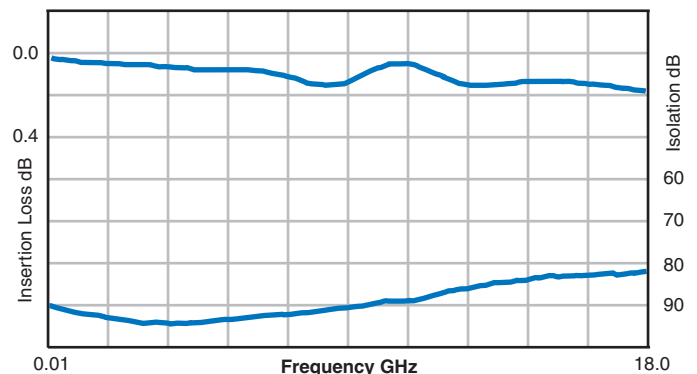


FEATURES

- Fully customized switching configurations
- Universal Power Supply
- Visual Display – LED
- Standard and custom racks available
- Manual/direct and/or remote control
- Multiple interface configurations:
RF ports – SMA, 2.92mm, N, SMB, TNC, etc.
Control – RS-232, Ethernet, USB, Keypad, etc.
- 50 and 75 ohm impedances

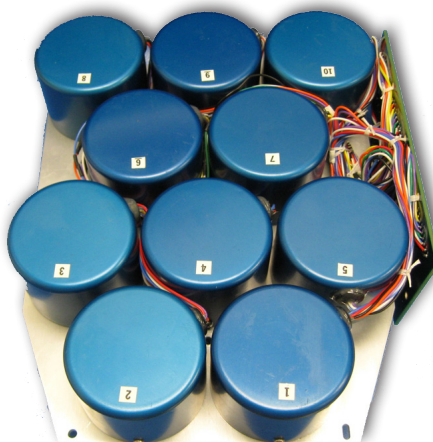


TYPICAL INSERTION LOSS / ISOLATION**



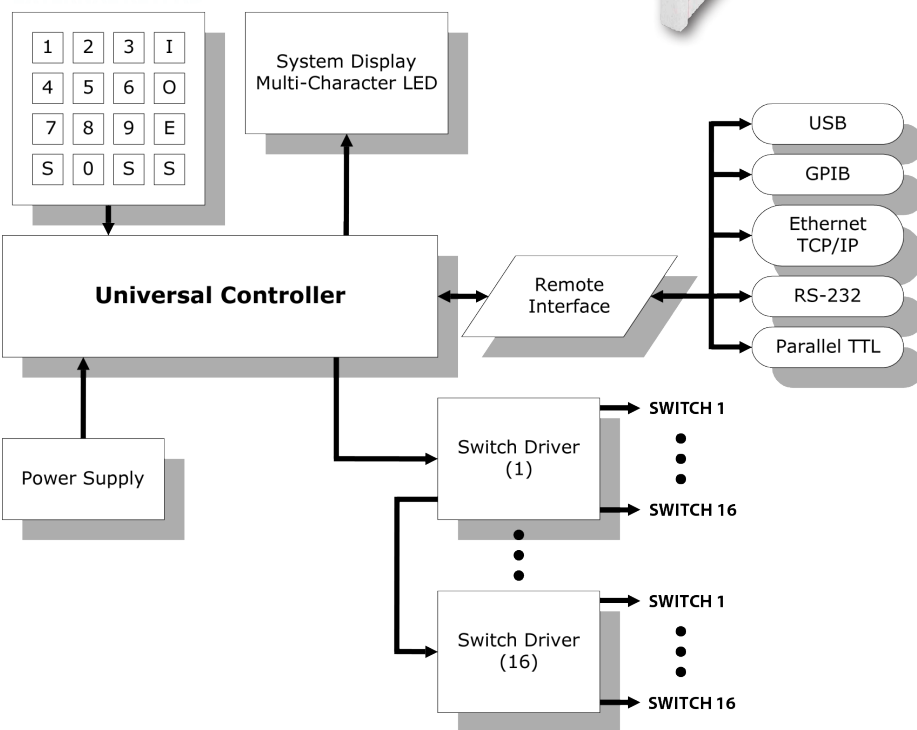


CUSTOM SWITCH MATRIX

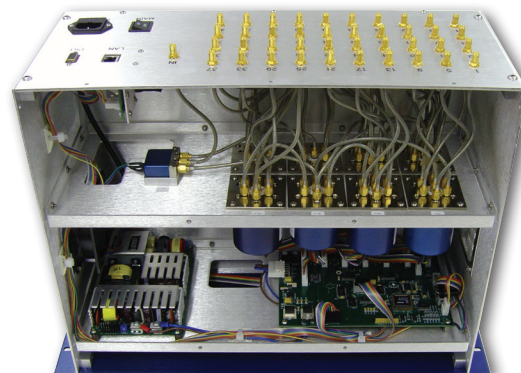
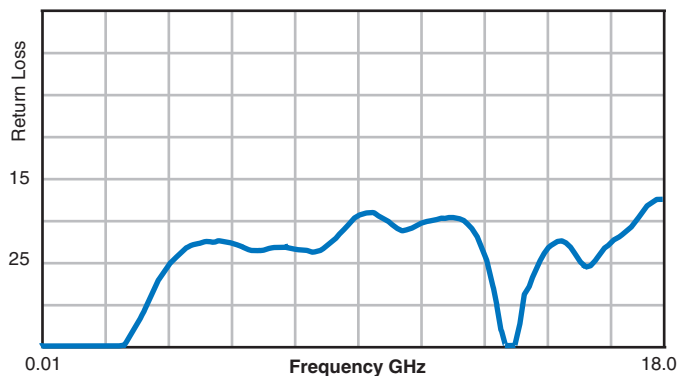


ADDITIONAL FEATURES

- Monitor cycle count
- System health/system status
- LEDs: Visual status
- In-circuit programming

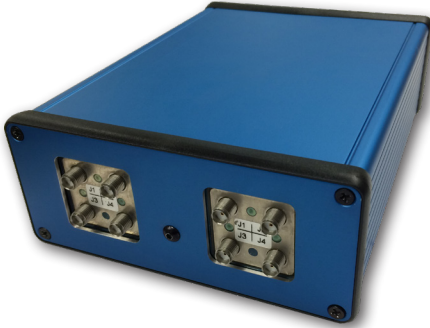


TYPICAL RETURN LOSS**



**Sample measurement from a 1x40 switch matrix.
For reference only, contact factory for additional details

Mini Matrix



The MMA, MMB & MMC series are an ideal solution that incorporate Teledyne Coax Switches with remote control via USB and/or TCP/IP (Ethernet). Remote operation is accomplished via Windows GUI or ASCII (command set provided).



TYPICAL RF CHARACTERISTICS

Frequency	DC-6 GHz	6-12 GHz	12-18 GHz	18-26.5 GHz	26.5-34 GHz	34-40 GHz	40-52 GHz
Insertion Loss	0.20 dB	0.40 dB	0.50 dB	0.90 dB	1.00 dB	1.20 dB	1.40 dB
Isolation	80 dB	80 dB	80 dB	70 dB	65 dB	60 dB	60 dB
VSWR	1.25:1	1.40:1	1.50:1	1.60:1	1.70:1	1.80:1	2.00:1

Mini Matrix
App Form!



- Off the Shelf design
- Open Port (Labview & C++ Compatible)
- Controller supports 2 x 8 output channels @ 24V
- Discrete control
- Controlled through USB/Ethernet
- Windows GUI & API provided

CONFIGURATIONS AVAILABLE

Series	Frequency	Connector Type	Quantity	Cycle Life
SPDT	18, 26.5, 40 GHz	SMA, 2.92mm	Up to 4 SPDT	5M Cycles
Transfer	18, 26.5 GHz	SMA, 2.92mm	Up to 4 Transfer	5M Cycles
Multi-Throw	18, 26.5, 40 GHz	SMA, 2.92mm	Up to 2 SP8T	5M Cycles

Airworthy Custom Matrix Boxes

Program Oriented Design Review

- Compliance Matrix
- Mechanical Layout
- Thermal Analysis
- Cascade Analysis with Tolerances
- Power Analysis



TESTING CAPABILITIES:

- Shock
- Ballistic Shock
- Crash Load
- Random Vibration
- Acoustic Noise
- Temperature
- Sinusoidal Vibration
- Altitude
- Humidity





For over fifty years Teledyne Relays has been supplying high reliability switching solutions intended for space flight applications. As the inventor of the ultra-miniature T0-5 electromechanical relay Teledyne Relays has been involved with all facets of the modern space age. From the earliest NASA missions Teledyne Relays has supplied T0-5 relays and RF Coax Switches for use in all type of space craft: manned, unmanned, deep space and robotic exploration.



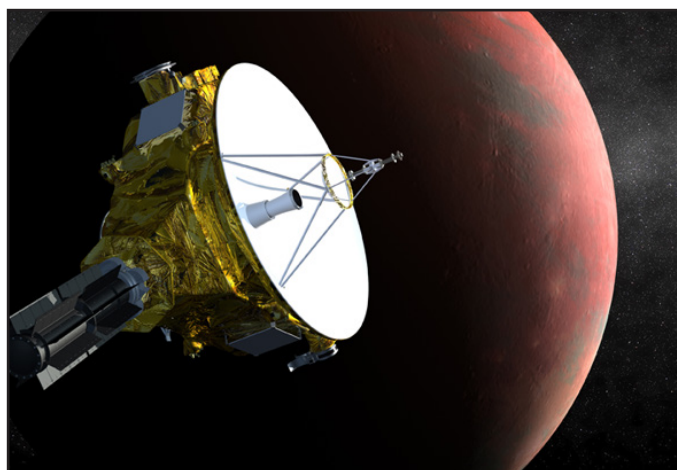
Ariane V Launch Vehicle

Space Market Segments Served:

- Deep-space Probes
- Manned Programs
- Communications Satellites
- Launch Vehicles
- Earth Observatory / Weather Satellites
- Commercial/Military Satellites

Capabilities:

- Logistic Infrastructure
- Chemical Analysis Lab
- Scanning Electro Microscope (SEM)
- In-house Plating Shop
- Environmental Test Lab
- Field Technical Support



New Horizons Spacecraft

SPACE STANDARDS



Specifications

- NASA/GSFC S-311-P-754
- NASA EEE-INST-002
- ESA/SCC 3601
- ESA/SCC 3602
- TR-HIREL-1

Certifications

- MIL-PRF-39016
- MIL-PRF-28776
- MIL-STD-790
- BOEING D1-9000
- ISO 9001:2008
- NASA/JEDEC Solder Requirements

Required Tests

- 100% Pre-Cap
- Small Particle Inspection (Millipore Inspection)
- Sinusoidal Vibration
- Resonant Beam Test
- P.I.N.D. Test
- Internal Moisture
- Temperature Condition, High and Low Temperature Miss Test
- Electrical Measurements
- Leak Test
- Radiographic Inspection (X-Ray)
- Visual Inspection

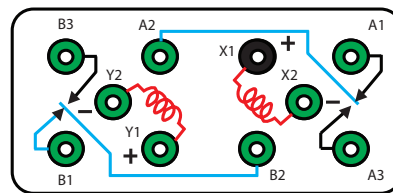


ELECTROMECHANICAL RELAYS

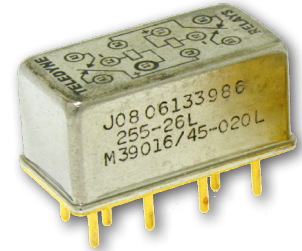
Contact Load and Life Ratings

LOAD LEVEL	CONTACT LOAD
Low level/Mechanical	10-50µA at 10-50 mVdc or Peak AC
Intermediate Current	100mA at 28Vdc
High Level, Resistive	2.0A at 28Vdc
High Level, Inductive	750 mA at 28Vdc, with 0.20H inductance
High Level, Lamp	160mA at 28Vdc
Overload, Resistive	4.0A at 28Vdc

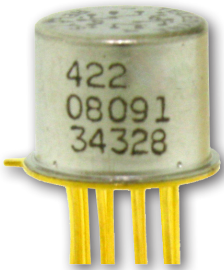
Form Factor	2 Form C (DPDT)	Operating Temperature	-65°C to +125°C
Frequency Range	DC-3 GHz	Vibration (Sinusoidal)	30 g's 10 to 2500 Hz
Lead Finish	Gold Plated or Solder Coated	Shock (Specific Pulse)	100 g's, 6ms half sine
Hermetic Seal	1 x 10 ⁻⁸ atm-cm ³ /s	Weight	0.10 oz. (2.84) max.



HR255 SHECMATIC



HR255



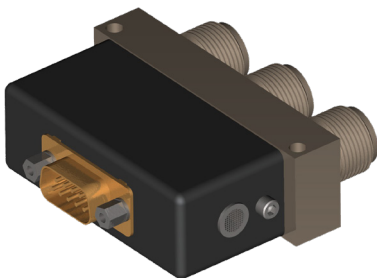
HR422 / HRS422



HR412 / HRS412

Form Factor	2 Form C (DPDT)	Operating Temperature	-65°C to +125°C
Frequency Range	DC-3 GHz	Vibration (Sinusoidal)	30 g's 10 to 2500 Hz
Lead Finish	Gold Plated or Solder Coated	Shock (Specific Pulse)	100 g's, 6ms half sine
Hermetic Seal	1 x 10 ⁻⁶ atm-cm ³ /s	Weight	0.10 oz. (2.84) max.

COAXIAL SPDT SWITCH

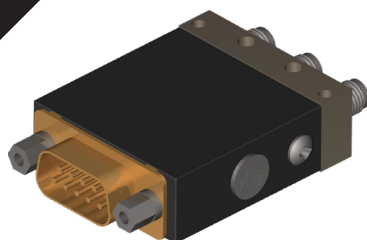


H-32N

Form Factor	SPDT, break before make
Frequency Range	L, S, C, X
RF Leakage	-95 dBc, 10dBm, @300 MHz
Characteristic Impedance	50 Ohms
Operating Temperature	-55°C to +85°C
Vibration, 10 ~ 2000 Hz, 300 s (MIL-STD-202 Method 214, Condition C)	10 G peak
Shock, Half-Sine Pulse (MIL-STD-202 Method 213, Condition D)	500 G peak

PERFORMANCE CHARACTERISTICS				
Frequency Option	F2 (L-BAND) DC-2 GHz	F4 (S-BAND) 2-4 GHz	F8 (C-BAND) 4-8 GHz	F12 (X-BAND) 8-12 GHz
Insertion Loss (max)	0.2 dB	0.3 dB	0.4 dB	0.55 dB
Isolation (min)	70 dB	70 dB	70 dB	60 dB
VSWR (max)	1.2:1	1.3:1	1.3:1	1.6:1

SPACE



H-33S

Form Factor	SPDT, break before make
Frequency Range	L, S, C, X, KU, K
RF Leakage	-95 dBc @ 300 MHz
Characteristic Impedance	50 Ohms
Operating Temperature	-55°C to +85°C
Vibration, 10 ~ 2000 Hz, 300 s MIL-STD-202 Method 214, Condition C	10 G peak
Shock, Half-Sine Pulse MIL-STD-202 Method 213, Condition D	500 G peak

PERFORMANCE CHARACTERISTICS						
Frequency Option	F2 (L-BAND) DC-2 GHz	F4 (S-BAND) 2-4 GHz	F8 (C-BAND) 4-8 GHz	F12 (X-BAND) 8-12 GHz	F18 (KU-BAND) 12-18 GHz	F26 (K-BAND) 18-26 GHz
Insertion Loss (max)	0.15 dB	0.25 dB	0.35 dB	0.35 dB	0.40 dB	0.65 dB
Isolation (min)	80 dB	70 dB	70 dB	70 dB	60 dB	55 dB
VSWR (max)	1.5:1	1.25:1	1.30:1	1.35:1	1.40:1	1.65:1

TRANSFER SWITCH



H-47N

PERFORMANCE CHARACTERISTICS				
Frequency Option	F2 (L-BAND) DC-2 GHz	F4 (S-BAND) 2-4 GHz	F8 (C-BAND) 4-8 GHz	F12 (X-BAND) 8-12 GHz
Insertion Loss (max)	0.2 dB	0.3 dB	0.4 dB	0.6 dB
Isolation (min)	70 dB	70 dB	60 dB	60 dB
VSWR (max)	1.20:1	1.30:1	1.40:1	1.65:1

Form Factor	Transfer, break before make
Frequency Range H-37N H-37S	L, S, C, X L, S, C, X, KU, K
RF Leakage H-37N H-37S	-95 dBc, 10dBm, @300 MHz -95 dBc @ 300 MHz
Characteristic Impedance	50 Ohms
Operating Temperature	-55°C to +85°C
Vibration, 10 ~ 2000 Hz, 300 s MIL-STD-202 Method 214, Condition C	10 G peak
Shock, Half-Sine Pulse MIL-STD-202 Method 213, Condition D	500 G peak



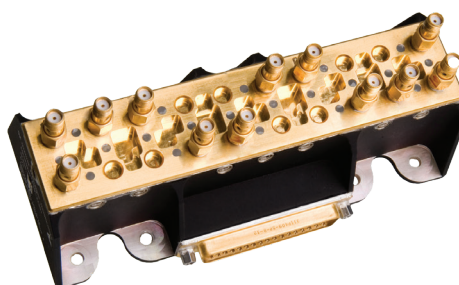
H-37S

PERFORMANCE CHARACTERISTICS					
Frequency Option	F2 (L-BAND) DC-2 GHz	F4 (S-BAND) 2-4 GHz	F8 (C-BAND) 4-8 GHz	F12 (X-BAND) 8-12 GHz	F18 (KU-BAND) 12-18 GHz
Insertion Loss (max)	0.15 dB	0.25 dB	0.35 dB	0.50 dB	0.65 dB
Isolation (min)	80 dB	70 dB	70 dB	70 dB	60 dB
VSWR (max)	1.15:1	1.30:1	1.35:1	1.40:1	1.60:1

SWITCH BLOCK

What is a switch block?

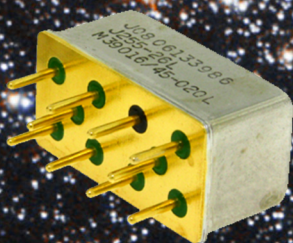
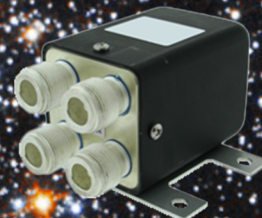
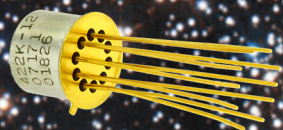
A switch block is a system composed of multiple individual space qualified switches connected to achieve multi-input and multi-output configurations, allowing you to reduce space. A switch block can consist of SPDT and Transfer switches to achieve customized switching configurations.



Teledyne Switch Blocks Feature:

- D-Connectors
- Custom Mounting
- Venting (Pressure Control)
- Custom switching patterns
- Transient Suppression (Diode Protection)
- Custom Telemetry Interfaces/Connections

Switching Solutions for Diverse Industries



TELEDYNE
RELAYS



TELEDYNE
COAX SWITCHES

Everywhereyoulook™





INDUSTRIAL SOLID STATE RELAYS (AC)



SH Series
Single Phase AC
Output to 125A, 690Vac
SSR w/ Touch-proof Flaps



S Series
Single Phase AC
Up to 125A, 660Vac
Hockey Puck SSR



DH Series
Single Phase AC
Up to 50A, 600Vac SSR



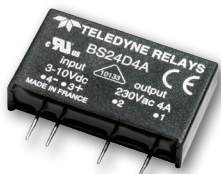
SD Series
Up to 50A 600Vac Hockey
Puck Dual SSR



FS Series
Single Phase AC
Up to 20A, 280Vac
Miniature SSR



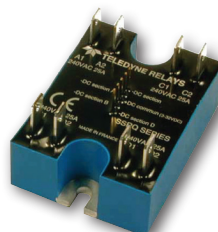
L Series
Single Phase AC
25A, 280Vac Ultraminiature SSR



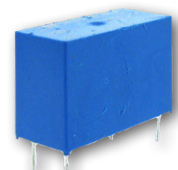
BS Series
Single Phase AC
4A, 600Vac SIP



E3P2G Series
Three Phase SSR
Up to 75A, 600Vac



SQ Series
Quad Output SSR
25A, 280Vac each



TS Series
Single Phase AC
2A, 275Vac PCB SSR

		CURRENT									
		≤ 125A									
		≤ 95A									
		≤ 75A									
		≤ 50A									
		≤ 35A									
		≤ 25A									
		≤ 12A									
		≤ 9A									
		≤ 4A									
AC	LINE VOLTAGE	240Vac (≤ 280Vac)	AS4			SH	SH	SH	SH	SH	SH
			BS		STH	STH	STH	STH			
					S	S	DRS	SHP			
					ST	ST					
								SD			
					FS	FS					
						DH					
						L					
						LS					
						C3P					
				SQ							
	480Vac (≤ 520Vac)	AS4		G	DR3P	SH	SH	SH	SH	SH	
				S3P							
					S		S	S	S	S	
						DH					
							SD				
						XV	E3P2G	E3P2G			
							E3PT				
				E3PT							
		600Vac (≤ 690Vac)	AS4			LS	LS	SH	SH	SH	SH
			BS				STH	STH	STH		
							S	S	S	S	
				ST	ST		ST	ST			
							SD				
							E3PT	SD			
					E3P2G	E3P2G		E3P2G	E3P2G		
						E3P2G	E3P2G				

INDUSTRIAL SOLID STATE RELAYS (DC)

		CURRENT									
		≤ 150A									
		≤ 125A									
		≤ 95A									
		≤ 75A									
		≤ 50A									
		≤ 35A									
		≤ 25A									
		≤ 12A									
		≤ 9A									
		≤ 4A									
DC	Voltage	≤ 36Vdc			LS10						
		≤ 60Vdc	DX					SHDC			S75
			DS								
		≤ 130Vdc					S20	SHDC			S20
		≤ 220Vdc	DX								
			DS								
		≤ 350Vdc						S60			SI



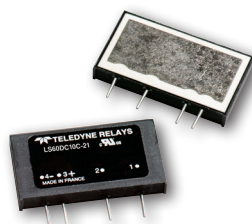
SI Series
DC SSR
Output up to 100A, 500Vdc



S60DC40 Series
DC SSR w/ status LED
Output 40A, 350Vdc



DX Series
Up to 3A, 60Vdc
DIN Rail SSR
Optional LED



LS10 Series
DC SSR
10A, 60Vdc PCB mount

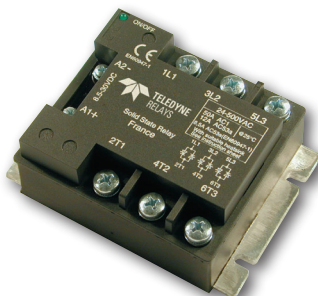


S75DC150 Series
DC SSR w/ status LED
Output 150A, 42Vdc



SHDC Series
Output up to 40A, 100Vdc
Over-voltage protection
IP20 touch-proof flaps

MOTOR CONTROLLERS



EMCRT Series

Part Number	Motor Current	Main Voltage	Peak Voltage	Switch Type	Control Voltage	I ² T
EMCRT48D50	8.5A	24-520 Vac	1600 Vpk	Zero Cross	12-30 Vdc	1500A ² S
EMCRT48D75	16A	24-550 Vac	1600 Vpk	Zero Cross	12-30 Vdc	5000A ² S

- Up to 10hp motors
- Controls and reverses 3-Phase motors without direct third leg (two legs)
- IP20 touch-proof housing
- Built-in snubber and MOV
- Very high immunity components, 1600Vpeak
- Forward/Reverse display LED

- Reduce high in-rush currents
- Reduce mechanical stress on load
- Heat Sink and Fan integrated
- Diagnostic feedback
- Soft-Start Motor Controller, designed for up to 25kW motors

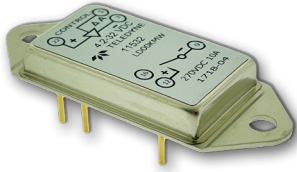


EMCRT Series

Max. Motor Power @40°C				IAC53a @40°C		Phase to Phase Voltage	Mains Frequency	Input	Status Output	In/Out/ Case Isolation	Operating Temp
Star (Y)		Delta (D)		Max.	EN60947- 4-2						
400Vac	230Vac	400Vac	230Vac								
15kW	8.6kW	26kW	15kW	30A	22.5A	200 to 480Vac	40 to 65Hz	10 to 24Vdc	24V/1A AC/DC	4kV	−40°C to +100°C

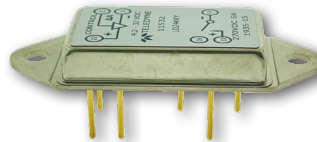


SILICON CARBIDE TECHNOLOGY

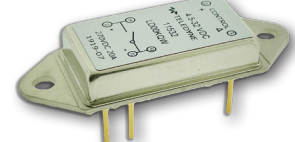


LD00KM
10A, 270Vdc Load
4.2-32Vdc Control

- Meets MIL-STD-704
- Tested Per MIL-PRF-28750
- Low ON resistance
- Low Profile
- Hermetic Package
- Silicon Carbide MOSFET

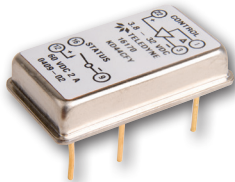


LD24KK
5A, 270Vdc Load
4.2-16Vdc Control
Short Circuit Protection & Trip Status



LD00KQ
20A, 270Vdc Load
4.2-18Vdc Control

DC SOLID STATE RELAYS

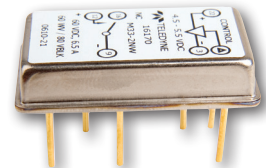


KD44CF
2A, 60Vdc Load
Direct, TTL or CMOS control

- Screened to MIL-PRF-28750
- Chassis & PCB Mount.
- Short-Circuit Protection
- Optical & Transformer Isolation
- Plastic & Hermetically Sealed

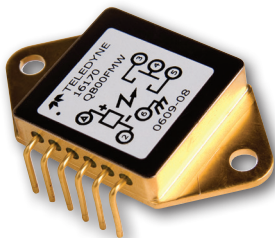


SR75-1ST
1.5A, 60Vdc Load
Surface Mount

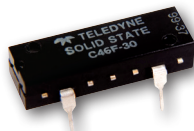


M33-2NW
7A, 60Vdc Load
Up to 100 Amp pulse load

BI-DIRECTIONAL / AC SOLID STATE RELAYS



QB00FM
7.5A, 150Vdc Load
 $\pm 4.3A$, $\pm 150Vac$ Load



C46F Series
Bi-directional

- Meet MIL-PRF-28750
- Tested Per MIL-STD-704
- Up to 250Vac, 25A
- Chassis & PCB Mount
- Short-Circuit Protection
- Plastic & Hermetically Sealed



652
25A, 250Vrms Load
Zero-Cross

MILITARY QUALIFIED SOLID STATE RELAYS



CD20CDY
DESC# 90091-004

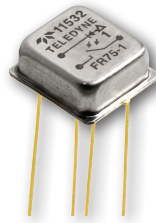
List of QPL & DESC
Qualified Part Numbers



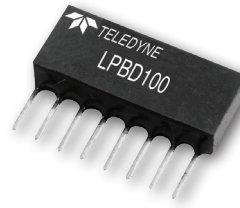
HD22CFY
DESC# 88062-002

COMMERCIAL

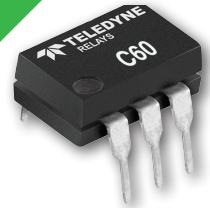
- Up to 250Vac, 10A
- Short-Circuit Protection
- Chassis and PCB Mount
- Zero-Cross & Random Switching
- Low Off-State Leakage Current



FR75-1



LPBD100



C60

SCREENING LEVELS

Inspection	S ² R Level "W"	S ² R Level "T"	MIL-PRF-28750 Level "Y"
Destructive Wirebond Pull Test (Sample test) MIL-STD-883 Method 2011	✓	✓	✓
Internal Visual MIL-STD-883 Method 2017	✓	✓	✓
Constant Acceleration MIL-STD-883 Method 2001, 5000 Gs, Y1 axis			✓
Temperature Cycling MIL-STD-883 Method 1010, 10 cycles	✓ Specified temp range	✓ Specified temp range	✓ -55° to +125°C
Load Conditioning 3 hours at rated input and load 90% duty cycle, 1 to 30 operations per second (latching fault indication for drop out)	✓	✓	✓
Pre Burn-In (optional)			✓
Burn-in Test MIL-STD-883 Method 1015, 160 hours at specified temperature and rated load (latching fault indication on failure)		✓ (48 hours of same testing for plastic- packaged relays)	✓
Dielectric Withstanding Voltage MIL-STD-202 Method 301	✓	✓	✓
Insulation Resistance MIL-STD-883 Method 1003	✓	✓	✓
Electrical Characteristics at -55°C		✓	✓
Electrical Characteristics at +25°C	✓	✓	✓
Electrical Characteristics at +125°C (or as specified)		✓	✓
Seal MIL-STD-202 Method 112 (Gross) MIL-STD-883 Method 1014 (Fine)	✓ (N/A for plastic- packaged relays)	✓ (N/A for plastic- packaged relays)	✓
Visual/Mechanical (Sample test)	✓	✓	✓
Solderability (2 Samples) MIL-STD-202 Method 208		✓	✓



Active RF Switches

DESCRIPTION

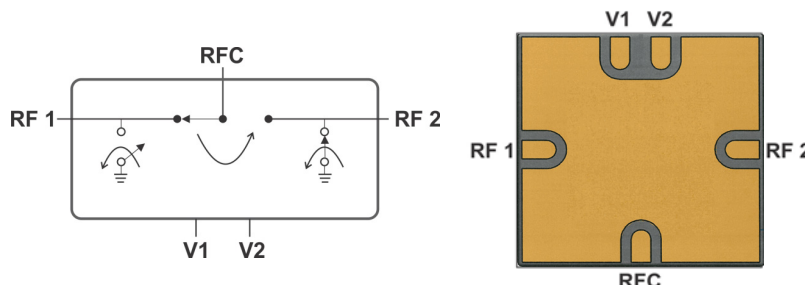
The InP1012-60 is a highly compact, reflective SPDT Active RF switch, manufactured using Teledyne's high-speed, low-loss InP HEMT process. The switch die is packaged in a low-loss, surface mount package, with a small form factor: 3mm (L) × 3mm (W) × 1mm (H). It supports a wide frequency range from DC to 60 GHz, and delivers low insertion loss, fast switching time, and good isolation—making this switch ideal for test and measurement, microwave communications, and radar applications. The InP1012-60 can also tolerate up to 100krads of radiation, allowing it to be used in space applications.

The following unique construction features and manufacturing techniques provide excellent robustness to environmental extremes and overall high reliability:

- Monolithic solid-state switch with no mechanical wear
- Flip-chip packaging provides shock & vibration resistance
- ENEPIG surface finish for solder bonding
- Low loss package with organic overmold
- Test board with K-connector can be provided

The InP1012-60 features:

- High digital bandwidth, greater than 40 Gbps
- Broad frequency bandwidth, DC - 60 GHz
- Small form factor, 3mm X 3mm X 1mm
- Low insertion loss
- Very High linearity
- Wide operating temperature
- Radiation tolerant up to 100krads
- Very fast switching time of less than 100ns



RECOMMENDED OPERATING CONDITIONS

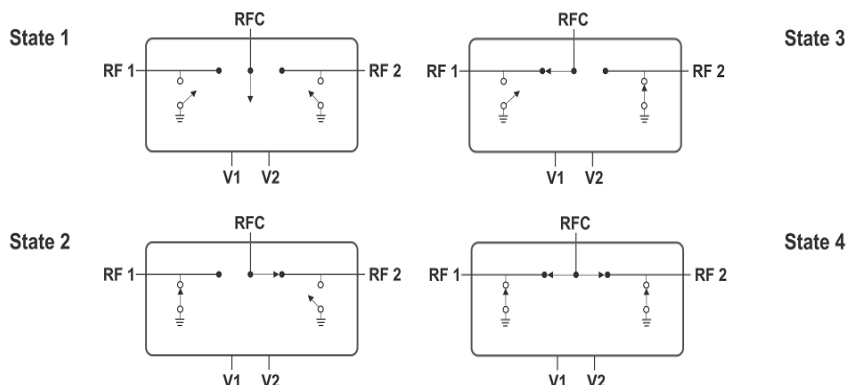
Parameter	MIN	TYP.	MAX	UNIT
Control ON (V1,V2)	-0.3	0	+0.3	V
Control OFF (V1,V2)	-2.0	-2.5	-3.0	V
Control Current		200	700	μA

ENVIRONMENTAL AND PHYSICAL SPECIFICATIONS		
Temperature (Ambient)	Storage	-65°C to +125°C
	Operating	-65°C to +125°C
Enclosure		Low-Loss Surface Mount Package
ESD Sensitivity (HBM)		Class 1
MSL Sensitivity		TBD
Radiation Tolerance		100krads

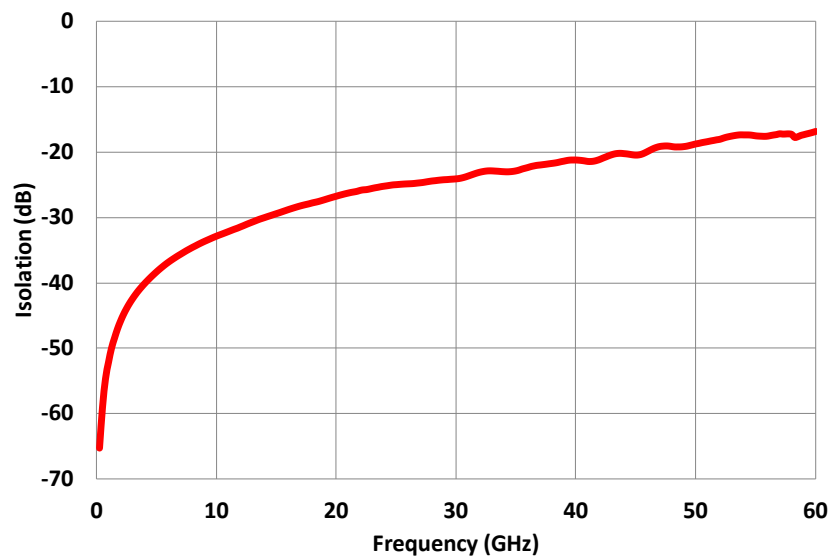
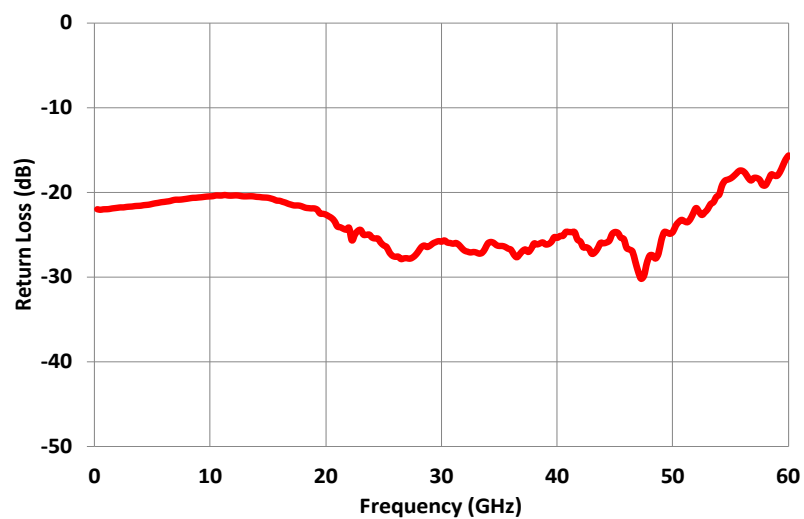
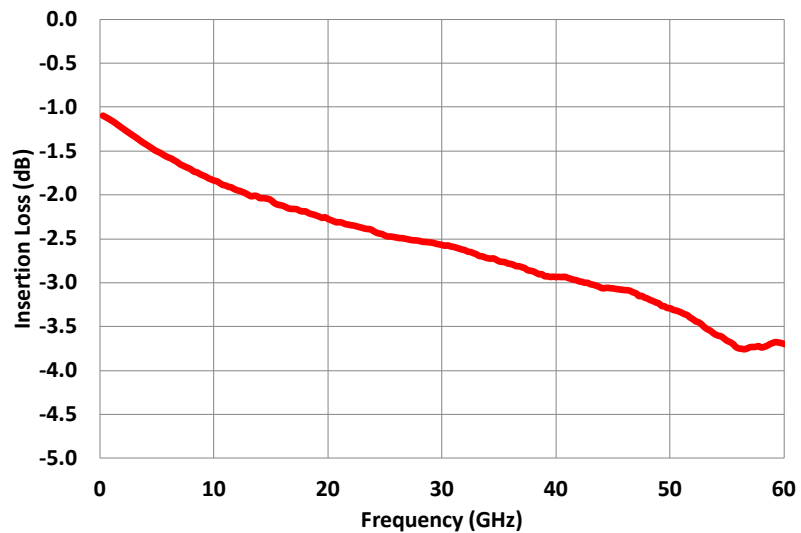
SWITCH STATES

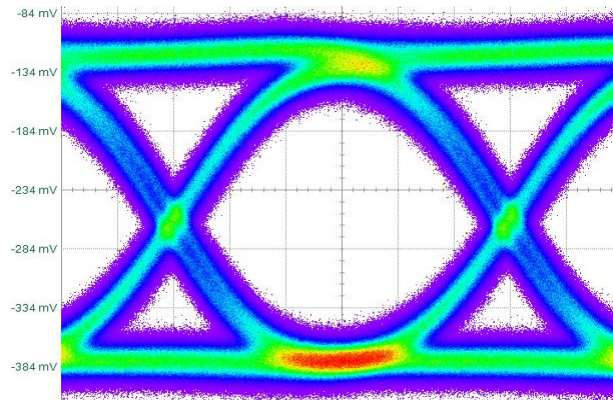
V1	V2	RF1	RF2	STATE
-2.5V	-2.5V	OFF	OFF	1
-2.5V	0V	OFF	ON	2
0V	-2.5V	ON	OFF	3
0V	0V	ON	ON	4

Note: Operation between -0.3V and -2.0V is not recommended.

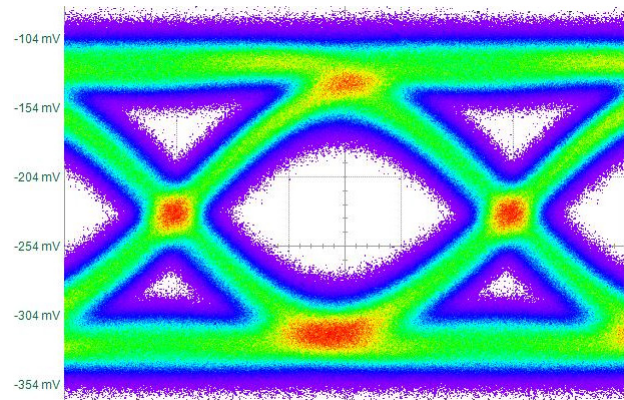


Insertion Loss and Isolation Plots

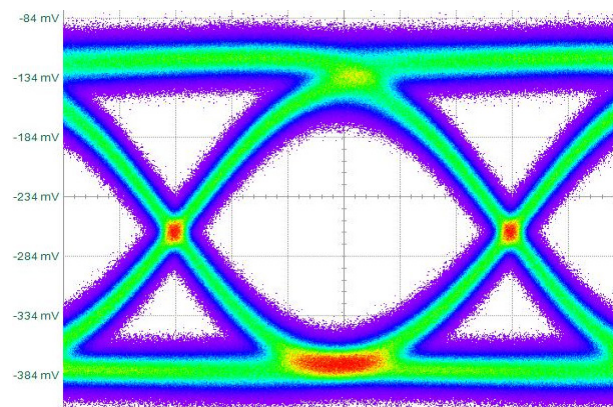




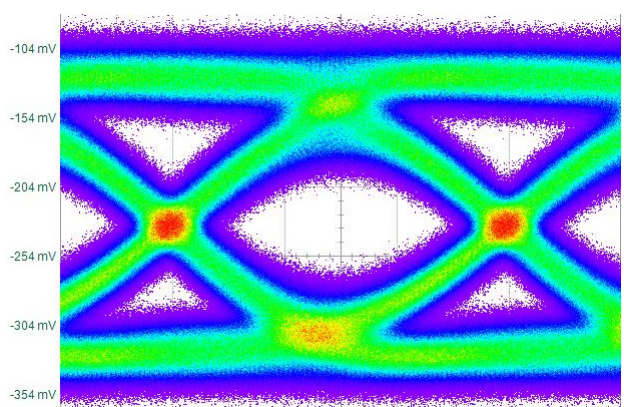
Reference @ 40 Gbps



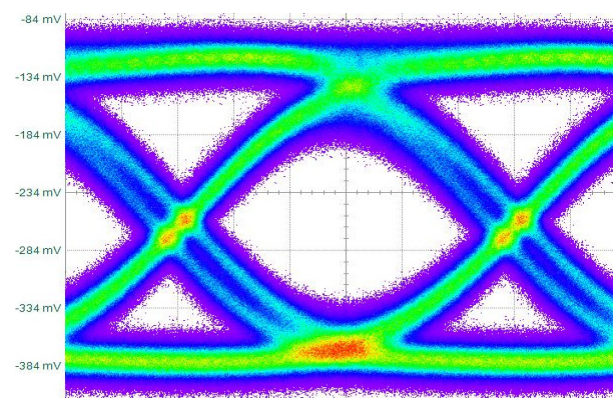
InP1012-60 @ 40 Gbps



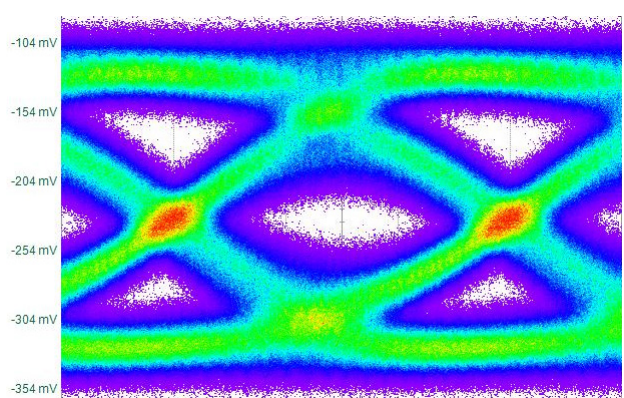
Reference @ 48 Gbps



InP1012-60 @ 48 Gbps



Reference @ 56 Gbps



InP1012-60 @ 56 Gbps

MEASUREMENTS NOTES

DUT measurements were made using an oscilloscope.
The relay was mounted on an evaluation board.

Pattern Generator Settings

- $2^{31}-1$ PRBS signal
- 40Gbps data rate
- Data amplitude of 500mVpp

Electrical Specifications

GENERAL ELECTRICAL SPECIFICATIONS (@25°C)

Contact Arrangement	1 Form C (SPDT)
Rated Duty	Continuous
Operating Power	1-2 mW
Switching Time	60-100 ns

TYPICAL ELECTRICAL SPECIFICATIONS

(@25°C, V1 = ON, V2 = OFF OR V1 = OFF, V2 = ON, $Z_s = Z_L = 50 \Omega$)

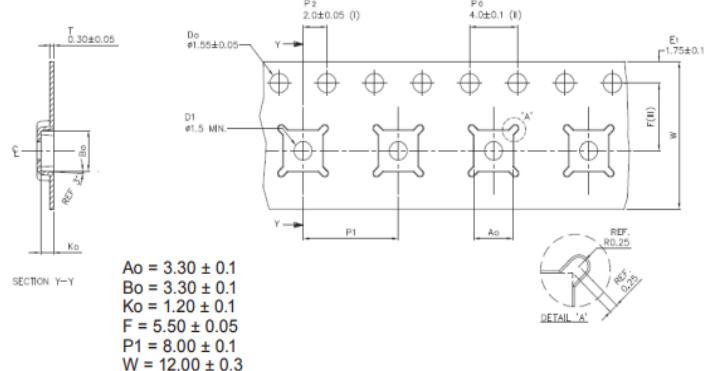
OPERATING FREQUENCY: DC - 60GHz

Parameter/Condition	Path	Condition	Typical	Unit
Insertion Loss	RFC-RFX	DC (20mV - 200mV) *	2.0	dB
		10 kHz	0.9	dB
		100 MHz	1.2	dB
		6 GHz	1.6	dB
		14 GHz	2.0	dB
		20 GHz	2.3	dB
		30 GHz	2.6	dB
		40 GHz	2.9	dB
		50 GHz	3.3	dB
		60 GHz	3.7	dB
Isolation	RFC-RFX	10 kHz	67	dB
		100 MHz	60	dB
		6 GHz	37	dB
		14 GHz	30	dB
		20 GHz	27	dB
		30 GHz	24	dB
		40 GHz	21	dB
		50 GHz	19	dB
		60 GHz	17	dB
Isolation	RF1-RF2	100 MHz	69	dB
		100 MHz - 26.5 GHz	32	dB
		26.5-40 GHz	27	dB
		45- 60 GHz	17	dB
Return Loss (active port)	RFC-RFX	100 MHz	23	dB
		6 GHz	21	dB
		14 GHz	21	dB
		20 GHz	23	dB
		30 GHz	26	dB
		40 GHz	25	dB
		50 GHz	25	dB
		60 GHz	16	dB
Input 0.1dB compression point		100 MHz	3.1	dBm
		6 GHz	15.7	dBm
		18 GHz	14.9	dBm
Input 1dB compression point		100 MHz	8.6	dBm
		6 GHz	21.1	dBm
		18 GHz	21.8	dBm
Input 3 rd Order Intercept (IIP3)		10GHz	37.5	dBm

DIE INFORMATION

PARAMETER	MIN	TYP	MAX	UNIT
Die Size, Singulated (x,y)	820 x 950	830 x 960	840 x 970	μm
Wafer Thickness	615	625	635	μm
Bump Pitch	150			μm
Bump Height	50	60	70	μm
Bump Diameter		79		μm
UBM Diameter	65	69	74	μm

TAPE AND REEL PACKAGING





HYBRID SOLUTIONS

Experienced in Custom Hybrid Solutions

Teledyne Relays is a leading manufacturer with the capability of providing build-to-print solutions on hybrid microcircuits devices. Our current products portfolio includes solid state power controllers, DC/DC converters, high current drivers, digital-analog converters, activator control hybrids, deflection amplifiers, base drivers, custom designed multi-layers thick-film/thin film substrates and many more...

With over 50 years of heritage in serving the space, aerospace, and defense markets, Teledyne continues to uphold the same standards and commitment to excellence. Our optimized solutions are supported by teams of engineers and manufacturing personnel with wide ranging experiences in developing products deployed in highly demanding applications, such as electrical power systems, radar receivers, and stores management solutions, for ground or aerial defense platforms.

Teledyne is accredited by Defense Logistics Agency (DLA) in accordance with MIL-PRF-38534, Class H and Class G Qualified Manufacturers List (QML). Since 2014 Teledyne has successfully launched over twenty hybrids into production for our customers. We welcome opportunities to partner with our customers to provide customized solutions to your hybrid needs. Our typical custom solution development cycle is as follows:



Submit an Inquiry Here!



HYBRID MICROCIRCUITS

General Hybrids Assembly

While there are different approaches in hybrid manufacturing, a standard hybrid involves the integration of active and passive chips into a substrate using eutectic and/or epoxy attach processes, substrate attachment to metal enclosure, clean, wire bonding, trim (as required) and test, and hermetic sealing. In essence chip-and-wire is the core technology of hybrid assembly utilizing different tightly controlled and repeatable processes to assemble products with precision, consistency and reliability. Such products will be subjected to the environmental stress screening (ESS) testing in accordance with the MIL-PRF-38534 unless otherwise specified by special customer requirements.

Hybrid Microcircuits vs Printed Circuit Assembly

There are substantial advantages in using hybrid microcircuits when compared to printed circuit assembly (PCA):

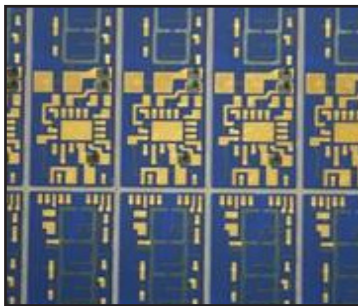
- **Miniaturization** - Hybrids utilize unpackaged dies which are significantly lower in size and weight than the packaged devices used on PCA. Although they may not be more economical to produce than PCA are, when the mass of PCA are considered in the overall cost hybrids become comparable in application where size and weight matters.
- **Hermetic Protection** - Hybrids are microcircuits contained within a hermetically sealed and corrosion resistance enclosure. All components are protected from moisture ingress or other adverse environmental changes.
- **Wider Operating Temperature Range** – Since materials used in hybrids microcircuits generally are capable of handling higher temperature than PCA materials can, hybrids microcircuit are designed into critical applications where wider temperature ranges are needed.
- **Better Thermal Management** – Commonly used PCB materials inherently has poor thermal conductivity creating hotspots which may affect life of the components mounted nearby. Hybrids use higher thermally conductive Alumina, Aluminum Nitride or Beryllium Oxide (BeO) substrates to help dissipate heat more uniformly over the surface and increase components lifespan in general.
- **Higher Reliability** – Hybrids use significantly fewer solder joints than PCA do which increase the fundamental reliability of the circuits. Since it is hermetically sealed, circuits interconnections are contained within the hybrid shielded from the adverse influence of the environment in which the application may be exposed to.
- **Recognized Qualification** – When required, hybrid microcircuit may be qualified in accordance with the MIL-PRF-38534 as a standalone item for Class G, Class H or Class K as applicable to demonstrate performance and reliability of such design. Standard hybrids are subjected to burn-in and MIL-PRF-38534 Group A screening requirements to assure high quality is maintained.

Teledyne Relays has developed extensive experience and strong capabilities in the following areas:

THICK & THIN FILM SUBSTRATES

Thin Film Substrates

- Ti-W, Au, Ni, NiCr, TaN on Al₂O₃, BeO, AlN
- Thermal Evaporation & Sputter Deposition
- Additive Process
- Etch-back Process



Thick Film Substrates

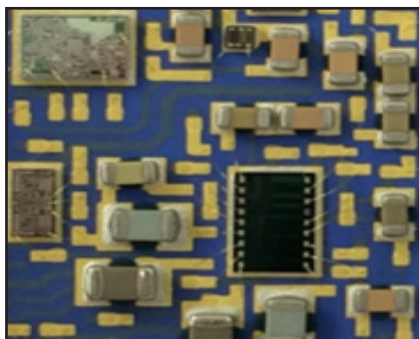
- Au/Ag on Al₂O₃, BeO, AlN
- Diffusion Patterning™
- Resistor Network
- Multiple Layers



COMPONENT & SUBSTRATE ATTACHMENT

Component Attachment

- Au/Ag on Al₂O₃, BeO, AlN
- Void-free Eutectic Die Attach
- Fully Automatic Pick and Place



Substrate Attachment

- Au/Ag on Al₂O₃, BeO, AlN
- DAP Vacuum Assisted Soldering Attach

WIRE BONDING



Automatic Wire bonding

- Hughes/Palomar
- Delvotec
- Orthodyne



Manual Wire bonding

- K&S
- High Bond
- Orthodyne



CLEANING & INSPECTION

Cleaning

- DL Aqueous
- Plasma
- Solvent



Inspection & Qualification

- XRF Scan
- Real Time X-ray
- Mechanical Shock
- Vibration (Random & Sine)
- Salt Atmosphere

ENVIRONMENTAL SCREENING & TESTING

Trim and Test

- Active Laser Trim
- Electrical Testing
- Fully Automated Test Systems



Hermetic Sealing & Burn-In

- Projection Weld & Seam Seal
- Pre-programmed Burn-in Cycling

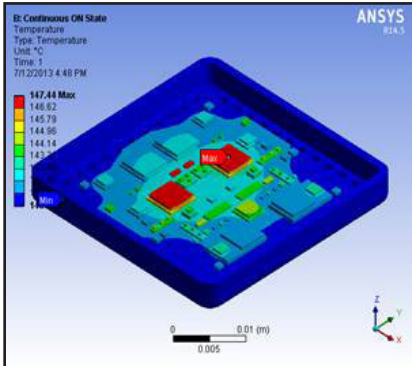


Environmental Stress Screening

- Temperature Cycle
- Centrifuge/Acceleration
- Particle Impact Noise Detection
- Fine & Gross Leak Test



ENGINEERING SERVICES



RoHS and REACH CERTIFICATE OF COMPLIANCE

RoHS

It is hereby stated and certified that Teledyne Relays complies with the Restrictions on Hazardous Substances, RoHS 3 Directive (2015/863/EU) Directives to the extent herein:

Teledyne Relays does not use any of the Restricted Substances specified by the RoHS Directives (listed below) as components in our Electromechanical Relay, Coax Switch, and Industrial Solid-State Relay products. None of these substances are employed during any manufacturing process:

- Lead
- Mercury
- Cadmium
- Hexavalent Chromium
- Polybrominated Biphenyls (PBB's)
- Polybrominated Diphenyl Ethers (PBDE's)
- 2-ethylhexyl) phthalate (DEHP)
- Butyl benzyl phthalate (BBP)
- Dibutyl phthalate (DBP)
- Diisobutyl phthalate (DIBP)

However, upon request from the Customer, relay leads may be coated with lead solder, which contains 60% tin and 40% lead.

REACH

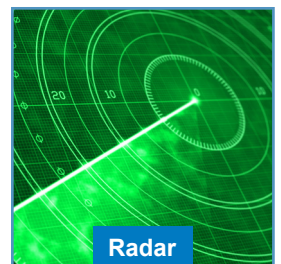
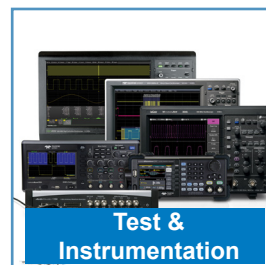
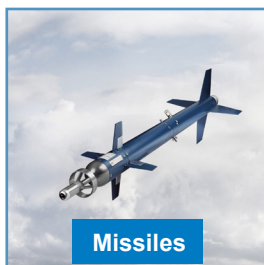
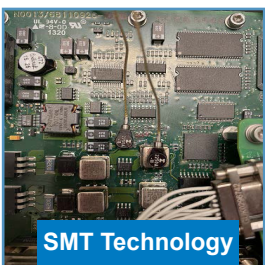
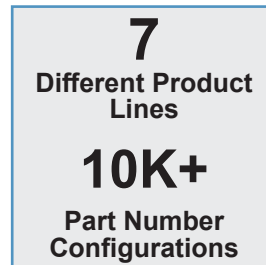
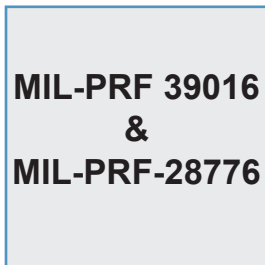
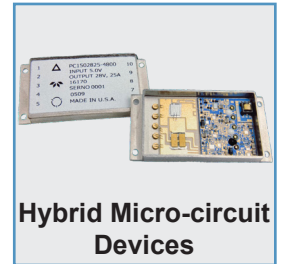
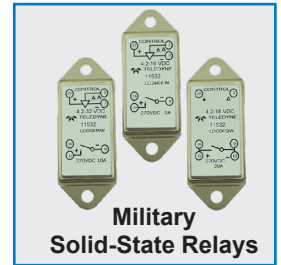
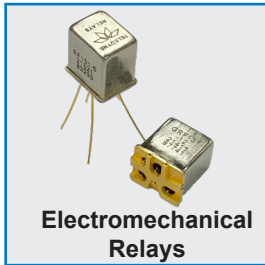
It is hereby stated and certified that Teledyne Relays complies with the Registration Evaluation Authorization and Restriction of Chemicals (REACH) Directives to the extent stated herein:

Teledyne Relays is a manufacturer of articles. Teledyne Relays has taken the initiative to review the (224) substances that are under consideration for treatment as Substances of Very High Concern (SVHC) candidates. Teledyne Relays confirmed that our relays do not contain any of the listed substances in concentration >0.1% weight per supplied article, substance or preparation weight.



For Additional Information please E-Mail us at: relays@teledyne.com

About Us



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